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| INFORMATION DISCLOSURE STATEMENT BY APPLICANT Form PTO-1449 (Modified) (Use several sheets if necessary) | | | | COMPLETE IF KNOWN | |
| | | | | Application Number | |
| | | | | Confirmation Number | |
| | | | | Filing Date | January 28, 2004 |
| | | | | First Named Inventor | Boon Suan Jeung |
| | | | | Group Art Unit | |
| Examiner Name | | | | | |
| Sheet | 1 | of | 3 | Attorney Docket No. | 108298631US1 |

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